### TLP108

TOSHIBA PHOTOCOUPLER IRED & PHOTO-IC

# **TLP108**

#### Isolated bus drivers High speed line receivers Microprocessor system interfaces

TOSHIBA

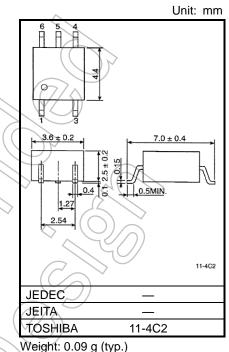
The Toshiba TLP108 consists of an infrared emitting diode optically coupled to a high-gain, high-speed photodetector. The TLP108 is housed in a 6-pin MFSOP. With a totem-pole output, the TLP108 is capable of both sinking and sourcing current. The TLP108 has an internal Faraday shield, which provides a guaranteed common-mode transient immunity. The TLP108 has an inverting output. A noninverting-output version, the TLP105, is also available.

- Inverter logic type (totem-pole output)
- Guaranteed Performance Over temperature: -40 to 100°C
- Power Supply Voltage: 4.5 to 20 V
- Input Threshold Current: I<sub>FHL</sub> =1.6 mA (max)
- Switching Time (t<sub>pLH</sub>/t<sub>pHL</sub>): 250 ns (max)
- Common mode transient immunity: 10 kV/µs
- Isolation Voltage: 3750 Vrms
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service

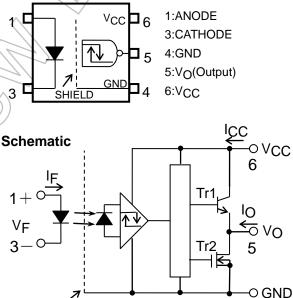
No.5A File No.E67349

 VDE-approved: EN 60747-5-5 (Note1)
 Note1 : When a VDE approved type is needed, Please designate the **Option(V4)**.

Truth Table								
	Input	LED	Tr1	Tr2	Output			
$\langle \rangle$	1	ON	OFF	OŅ	Y			
	4	OFF	ON	ÓFF	Н			



#### Pin Configuration (top View)



0.1  $\mu$ F bypass capacitor must be connected between pin 6 and 4.

SHIÉLD

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#### **Recommended Operating Conditions**

Characteristics	Synbol	Min	Тур.	Max	Unit	
Input Current , ON	I <sub>F(ON)</sub>	2	_	10	mA	
Input Voltage , OFF	VF(OFF)	0	_	0.8	V	
Supply Voltage*	VCC	4.5	_	20	V 🔿	
Operating Temperature	Topr	-40	_	100	°C	$\geq$
Fan-out (TTL Load)	Ν	_	—	4	_ (	(

\* This item denotes operating range, not meaning of recommended operating conditions.

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

	Characteristics	Synbol	Rating	Unit
	Forward Current		20 🛇	mA
	Forward Current Derating (Ta $\ge$ 83°C)	∆F/°C	-0.48	mA/°C
LED	Peak Transient Forward Current (Note 1)	IFPT	1 ((	A
	Input Power Dissipation	PD	40	mW
	Reverse Voltage	V <sub>R</sub>	(5/\$	V
	Output Current 1 (Ta ≤ 25°C)	I01	25/-15	mA
	Output Current 2 (Ta $\leq$ 100°C)	102	5/-5	mA
TOR	Output Current Derating (Ta ≥ 25°C)	∆l <sub>01</sub> /°C	-0.26/-0.13	mA/°C
DETECTOR	Peak Output Current (Note 2)	IOP	50/-50	mA
ШО	Output Voltage	Vo	-0.5 to 20	V
	Output Power Dissipation	Po	75	mW
	Supply Voltage	VCC	-0.5 to 20	V
pera	ating Temperature Range	Topr	-40 to 100	°C
tora	ge Temperature Range	T <sub>stg</sub>	-55 to 125	°C
ead	Solder Temperature (10 s)	T <sub>sol</sub>	260	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width  $\leq$  1 µs, 300 pps.

Note 2: Pulse width  $\leq$  5  $\mu$ s, duty cycle  $\leq$  0.025

Note 3: Device considered a two terminal device: pins 1 and 3 shorted together and pins 4, 5 and 6 shorted together.

#### Electrical Characteristics (Unless otherwise specified, Ta = -40 to 100°C, V<sub>CC</sub> = 4.5 to 20 V)

Characteristics	Symbol	Test Circuit	Cor	dition	Min	Тур.	Max	Unit
Input Forward Voltage	۷ <sub>F</sub>	_	I <sub>F</sub> = 10 mA, Ta = 25 °C		1.45	1.57	1.75	V
Temperature Coefficient of Forward Voltage	ΔV <sub>F</sub> /ΔTa	_	I <sub>F</sub> = 10 mA			-2.0	_	mV/°C
Input Reverse Current	IR	_	V <sub>R</sub> = 5 V, Ta = 25 °C		£	)ř	10	μA
Input Capacitance	CT	_	V = 0 V, f = 1 MH	lz, Ta = 25 °C	77	100	_	pF
Logic Low Output Voltage	VOL	1	I <sub>OL</sub> = 3.5 mA , I <sub>F</sub>	: = 5 mA	$\bigcirc$	0.2	0.6	V
		_	I <sub>OH</sub> = −2.6 mA,	V <sub>CC</sub> = 4.5 V	2.7	4.0	_	
Logic High Output Voltage	VOH	2	V <sub>F</sub> = 0.8 V	$V_{CC} = 20 V$	17.4	19.0	-	V
Logic Low Supply Current	ICCL	3	I <sub>F</sub> = 5 mA	$V_{CC} = 20 V$ $V_{CC} = 5.5 V$	_	$\mathcal{A}$	3.0 3.0	mA
Logic High Supply Current	ІССН	4	V <sub>F</sub> = 0 V	$V_{CC} = 20 V$ $V_{CC} = 5.5 V$			3.0 3.0	mA
Logic Low Short Circuit Output Current (Note 1)	IOSL	5	$I_F = 5 mA$ $V_O = GND$	$V_{CC} = V_O = 5.5 V$ $V_{CC} = V_O = 20 V$	20 15	80 90	_	mA
Logic High Short Circuit Output Current (Note 1)	IOSH	6	VF=0V	$V_{CC} = 5.5 V$ $V_{CC} = 20 V$	-10	-15 -20	_	mA
Input Current Logic Low Output	IFHL		lo = 3.5 mA, V <sub>O</sub>			0.4	1.6	mA
Input Voltage Logic High Output	V <sub>FLH</sub>		l <sub>O</sub> = −2.6 mA, V <sub>O</sub>	O > 2.4 V	0.8	_		V
Input Current Hysteresis	IHYS		V <sub>CC</sub> = 5 V		_	0.05	_	mA

\*All typical values are at  $Ta = 25 \circ C$ 

Note 1: Duration of output short circuit time should not exceed 10 ms.

#### Isolation Characteristics (Ta = 25°C)

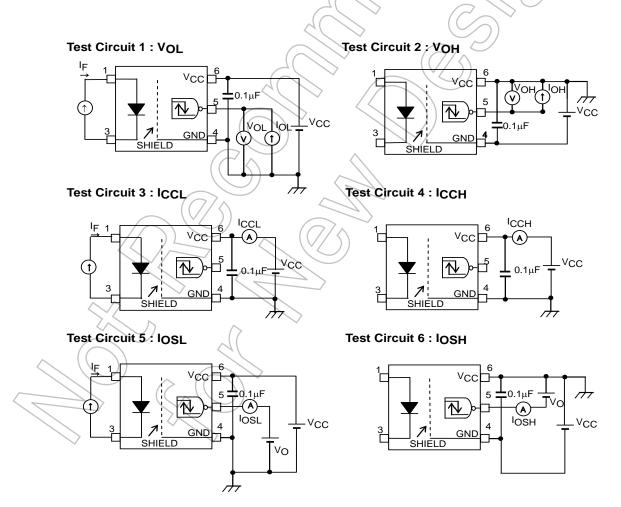
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> = 0 V,f = 1 MHz	_	0.8	—	pF
Isolation resistance	RS	$\text{R.H.} \leq 60 \text{ \%,V}_\text{S} = 500 \text{ V}$	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVS	AC,60 s	3750	-		V <sub>rms</sub>

Note : Device considered a two terminal device: pins 1 and 3 shorted together and pins 4, 5 and 6 shorted together.

#### Switching Characteristics (Unless otherwise specified, Ta = -40 to 100°C, V<sub>CC</sub> = 4.5 to 20 V)

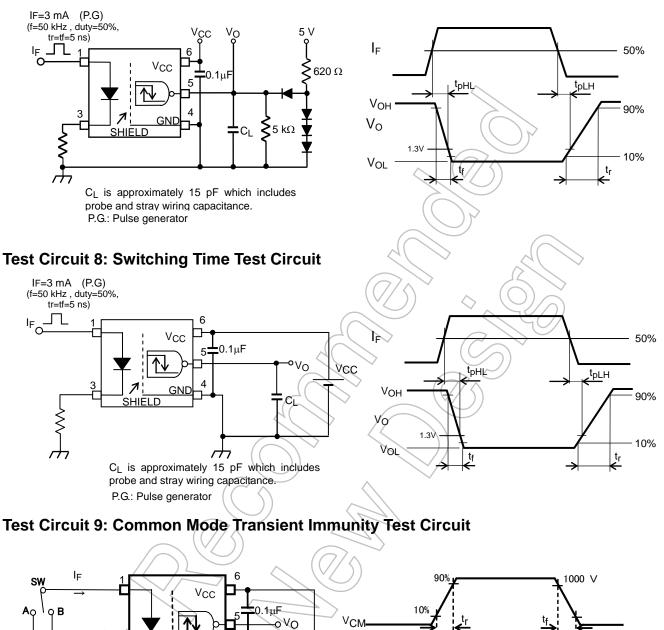
Characteristics	Symbol	Test Circuit	Condition	Min	Тур.	Max	Unit
Propagation Delay Time to Logic High output	<sup>t</sup> pLH		I <sub>F</sub> =3→0 mA	30	150	250	ns
Propagation Delay Time to Logic Low output	<sup>t</sup> pHL		I <sub>F</sub> = 0→3 mA	30	150	250	ns
Switching Time Dispersion between ON and OFF	<sup> t</sup> pHL⁻ <sup>t</sup> pLH∣	7, 8	-	$\overline{O}$		220	ns
Rise Time (10 – 90 %)	tr		I <sub>F</sub> = 3→0 mA, V <sub>CC</sub> = 5 V		30	75	ns
Fall Time (90 – 10 %)	t <sub>f</sub>		$I_F = 0 \rightarrow 3 \text{ mA}, V_{CC} = 5 \text{ V}$	A	30	75	ns
Common Mode transient Immunity at High Level Output	СМ <sub>Н</sub>		V <sub>CM</sub> = 1000 V <sub>P-P</sub> , I <sub>F</sub> = 0 mA, V <sub>CC</sub> = 20 V, Ta = 25 °C	-10000	_ (	$\leq$	V/µs
Common Mode transient Immunity at Low Level Output	CML	9	$V_{CM} = 1000$ $V_{p-p}$ , $I_F = 5$ mA, $V_{CC} = 20$ V, Ta = 25 °C	10000	TAL (		V/µs

\*All typical values are at Ta = 25  $^\circ\text{C}$ 



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#### **Test Circuit 7: Switching Time Test Circuit**



Vcc

Vo

• SW B : IF = 0 mA

• SW A : I<sub>F</sub> = 5 mA

– 17 V

 $CM_{H} = \frac{800(V)}{t_{f}(\mu s)}$   $CM_{L} = \frac{800(V)}{t_{r}(\mu s)}$ 

GND

SHIELD

VСМ

CMH

CML

1V

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